



Welcome to **E-XFL.COM**

Understanding Embedded - CPLDs (Complex Programmable Logic Devices)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details	
Product Status	Obsolete
Programmable Type	In-System Reprogrammable™ (ISR™) CMOS
Delay Time tpd(1) Max	12 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	-
Number of Macrocells	32
Number of Gates	-
Number of I/O	37
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy37032vp44-100axit

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong





resources for pinout flexibility, and a simple timing model for consistent system performance.

REGISTERED SIGNAL

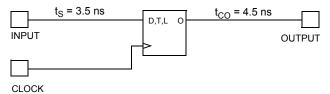


Figure 5. Timing Model for CY37128

JTAG and PCI Standards

PCI Compliance

5V operation of the Ultra37000 is fully compliant with the PCI Local Bus Specification published by the PCI Special Interest Group. The 3.3V products meet all PCI requirements except for the output 3.3V clamp, which is in direct conflict with 5V tolerance. The Ultra37000 family's simple and predictable timing model ensures compliance with the PCI AC specifications independent of the design.

IEEE 1149.1-compliant JTAG

The Ultra37000 family has an IEEE 1149.1 JTAG interface for both Boundary Scan and ISR.

Boundary Scan

The Ultra37000 family supports Bypass, Sample/Preload, Extest, Idcode, and Usercode boundary scan instructions. The JTAG interface is shown in *Figure 6*.

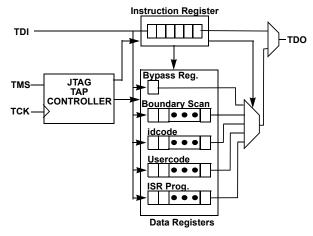


Figure 6. JTAG Interface

In-System Reprogramming (ISR)

In-System Reprogramming is the combination of the capability to program or reprogram a device on-board, and the ability to support design changes without changing the system timing or device pinout. This combination means design changes during debug or field upgrades do not cause board respins. The Ultra37000 family implements ISR by providing a JTAG compliant interface for on-board programming, robust routing

Development Software Support

Warp

Warp is a state-of-the-art compiler and complete CPLD design tool. For design entry, Warp provides an IEEE-STD-1076/1164 VHDL text editor, an IEEE-STD-1364 Verilog text editor, and a graphical finite state machine editor. It provides optimized synthesis and fitting by replacing basic circuits with ones pre-optimized for the target device, by implementing logic in unused memory and by perfect communication between fitting and synthesis. To facilitate design and debugging, Warp provides graphical timing simulation and analysis.

Warp Professional™

Warp Professional contains several additional features. It provides an extra method of design entry with its graphical block diagram editor. It allows up to 5 ms timing simulation instead of only 2 ms. It allows comparison of waveforms before and after design changes.

Warp Enterprise™

Warp Enterprise provides even more features. It provides unlimited timing simulation and source-level behavioral simulation as well as a debugger. It has the ability to generate graphical HDL blocks from HDL text. It can even generate testbenches.

Warp is available for PC and UNIX platforms. Some features are not available in the UNIX version. For further information see the Warp for PC, Warp for UNIX, Warp Professional and Warp Enterprise data sheets on Cypress's web site (www.cypress.com).

Third-Party Software

Although *Warp* is a complete CPLD development tool on its own, it interfaces with nearly every third party EDA tool. All major third-party software vendors provide support for the Ultra37000 family of devices. Refer to the third-party software data sheet or contact your local sales office for a list of currently supported third-party vendors.

Programming

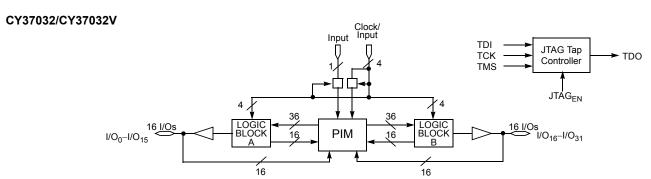
There are four programming options available for Ultra37000 devices. The first method is to use a PC with the 37000 UltraISR programming cable and software. With this method, the ISR pins of the Ultra37000 devices are routed to a connector at the edge of the printed circuit board. The 37000 UltraISR programming cable is then connected between the parallel port of the PC and this connector. A simple configuration file instructs the ISR software of the programming operations to be performed on each of the Ultra37000 devices in the system. The ISR software then automatically completes all of the necessary data manipulations required to accomplish the programming, reading, verifying, and other ISR functions. For more information on the Cypress ISR Interface, see the ISR Programming Kit data sheet (CY3700i).

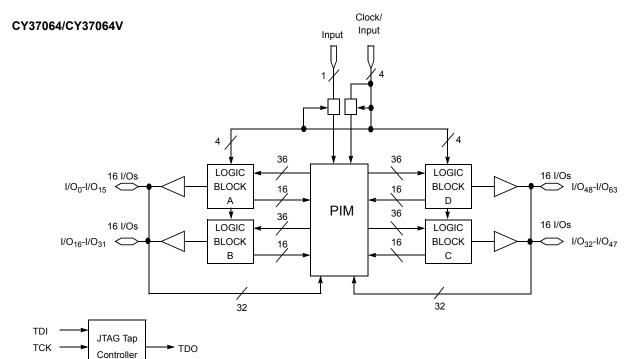
The second method for programming Ultra37000 devices is on automatic test equipment (ATE). This is accomplished through a file created by the ISR software. Check the Cypress website for the latest ISR software download information.





Logic Block Diagrams





TMS





Parameter	Description	Test Conditions			44-Lead CLCC				160-Lead TQFP	208-Lead PQFP	Unit
	Maximum Pin Inductance	V _{IN} = 5.0V at f = 1 MHz	2	5	2	8	5	8	9	11	nH

Capacitance^[5]

Parameter	Description	Test Conditions	Max.	Unit
C _{I/O}	Input/Output Capacitance	$V_{IN} = 5.0V$ at f = 1 MHz at $T_A = 25$ °C	10	pF
C _{CLK}	Clock Signal Capacitance	V_{IN} = 5.0V at f = 1 MHz at T_A = 25°C	12	pF
C _{DP}	Dual-Function Pins ^[9]	V_{IN} = 5.0V at f = 1 MHz at T_A = 25°C	16	pF

Endurance Characteristics^[5]

Parameter	Description	Test Conditions	Min.	Тур.	Unit
N	Minimum Reprogramming Cycles	Normal Programming Conditions ^[2]	1,000	10,000	Cycles

3.3V Device Characteristics **Maximum Ratings**

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature-65°C to +150°C

Ambient Temperature with

Power Applied55°C to +125°C

Supply Voltage to Ground Potential –0.5V to +4.6V

DC Voltage Applied to Outputs	
in High-Z State	–0.5V to +7.0V
DC Input Voltage	0.5V to +7.0V
DC Program Voltage	3.0 to 3.6V
Current into Outputs	8 mA
Static Discharge Voltage(per MIL-STD-883, Method 3015)	> 2001V

Latch-up Current.....> 200 mA

Operating Range^[2]

Range	Ambient Temperature ^[2]	Junction Temperature	V cc ^[10]
Commercial	0°C to +70°C	0°C to +90°C	3.3V ± 0.3V
Industrial	–40°C to +85°C	–40°C to +105°C	$3.3V \pm 0.3V$
Military ^[3]	–55°C to +125°C	–55°C to +130°C	3.3V ± 0.3V

3.3V Device Electrical Characteristics Over the Operating Range

Parameter	Description	Test Conditions	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	V_{CC} = Min. I_{OH} = -4 mA (Com'I) ^[4] I_{OH} = -3 mA (MiI) ^[4]	2.4		V
V _{OL}	Output LOW Voltage	V_{CC} = Min. I_{OL} = 8 mA (Com'I) ^[4] I_{OL} = 6 mA (MiI) ^[4]		0.5	V
V _{IH}	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs ^[7]	2.0	5.5	V
V _{IL}	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs ^[7]	-0.5	0.8	V
I _{IX}	Input Load Current	V_I = GND OR V_{CC} , Bus-Hold Disabled	-10	10	μА
l _{OZ}	Output Leakage Current	V_O = GND or V_{CC} , Output Disabled, Bus-Hold Disabled	-50	50	μА
Ios	Output Short Circuit Current ^[5, 8]	V _{CC} = Max., V _{OUT} = 0.5V	-30	-160	mA
I _{BHL}	Input Bus-Hold LOW Sustaining Current	V _{CC} = Min., V _{IL} = 0.8V	+75		μΑ
I _{BHH}	Input Bus-Hold HIGH Sustaining Current	V _{CC} = Min., V _{IH} = 2.0V	-75		μΑ
I _{BHLO}	Input Bus-Hold LOW Overdrive Current	V _{CC} = Max.		+500	μА
Івнно	Input Bus-Hold HIGH Overdrive Current	V _{CC} = Max.		-500	μА

^{9.} Dual pins are I/O with JTAG pins.
10. For CY37064VP100-143AC, CY37064VP100-143BBC, CY37064VP44-143AC, CY37064VP48-143BAC; Operating Range: V_{CC} is 3.3V± 0.16V.





$\textbf{Switching Characteristics} \ \, \text{Over the Operating Range (continued)}^{[12]}$

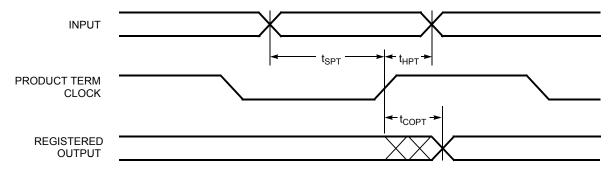
Parameter	Description	Unit
Product Term Clo	cking Parameters	1
t _{COPT} [13, 14, 15]	Product Term Clock or Latch Enable (PTCLK) to Output	ns
t _{SPT}	Set-Up Time from Input to Product Term Clock or Latch Enable (PTCLK)	ns
t _{HPT}	Register or Latch Data Hold Time	ns
t _{ISPT} ^[13]	Set-Up Time for Buried Register used as an Input Register from Input to Product Term Clock or Latch Enable (PTCLK)	ns
t _{IHPT}	Buried Register Used as an Input Register or Latch Data Hold Time	ns
t _{CO2PT} ^[13, 14, 15]	Product Term Clock or Latch Enable (PTCLK) to Output Delay (Through Logic Array)	ns
Pipelined Mode P	arameters	1
t _{ICS} ^[13]	Input Register Synchronous Clock (CLK_0 , CLK_1 , CLK_2 , or CLK_3) to Output Register Synchronous Clock (CLK_0 , CLK_1 , CLK_2 , or CLK_3)	ns
Operating Freque	ncy Parameters	
f _{MAX1}	Maximum Frequency with Internal Feedback (Lesser of $1/t_{SCS}$, $1/(t_{S} + t_{H})$, or $1/t_{CO}$) ^[5]	MHz
f _{MAX2}	Maximum Frequency Data Path in Output Registered/Latched Mode (Lesser of $1/(t_W + t_W)$, $1/(t_S + t_H)$, or $1/(t_{CO})^{[5]}$	MHz
f _{MAX3}	Maximum Frequency with External Feedback (Lesser of 1/(t _{CO} + t _S) or 1/(t _{WL} + t _{WH}) ^[5]	MHz
f _{MAX4}	Maximum Frequency in Pipelined Mode (Lesser of 1/(t_{CO} + t_{IS}), 1/ t_{ICS} , 1/(t_{WL} + t_{WH}), 1/(t_{IS} + t_{IH}), or 1/ t_{SCS}) ^[5]	MHz
Reset/Preset Para	ameters	
t _{RW}	Asynchronous Reset Width ^[5]	ns
t _{RR} ^[13]	Asynchronous Reset Recovery Time ^[5]	ns
t _{RO} ^[13, 14, 15]	Asynchronous Reset to Output	ns
t _{PW}	Asynchronous Preset Width ^[5]	ns
t _{PR} ^[13]	Asynchronous Preset Recovery Time ^[5]	ns
t _{PO} ^[13, 14, 15]	Asynchronous Preset to Output	ns
User Option Para	meters	
t _{LP}	Low Power Adder	ns
t _{SLEW}	Slow Output Slew Rate Adder	ns
t _{3.310}	3.3V I/O Mode Timing Adder ^[5]	ns
JTAG Timing Pa	rameters	•
t _{S JTAG}	Set-up Time from TDI and TMS to TCK ^[5]	ns
t _{H JTAG}	Hold Time on TDI and TMS ^[5]	ns
t _{CO JTAG}	Falling Edge of TCK to TDO ^[5]	ns
f_{JTAG}	Maximum JTAG Tap Controller Frequency ^[5]	ns



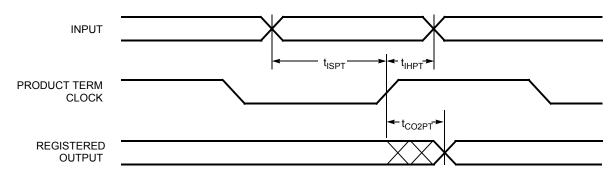


Switching Waveforms (continued)

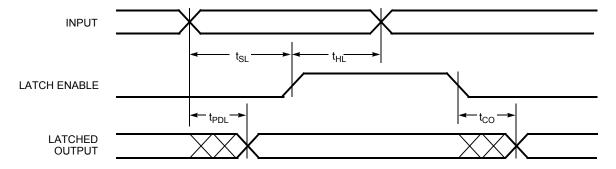
Registered Output with Product Term Clocking Input Going Through the Array



Registered Output with Product Term Clocking Input Coming From Adjacent Buried Register



Latched Output

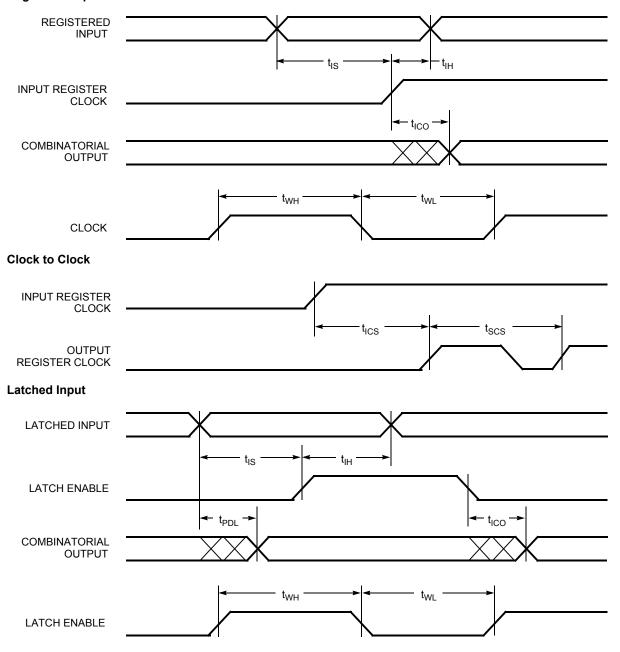






Switching Waveforms (continued)

Registered Input

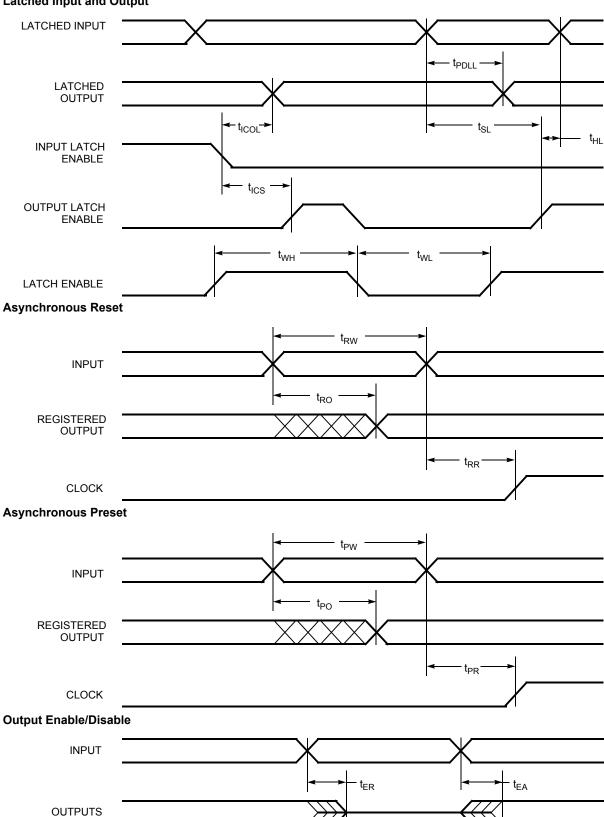






Switching Waveforms (continued)

Latched Input and Output

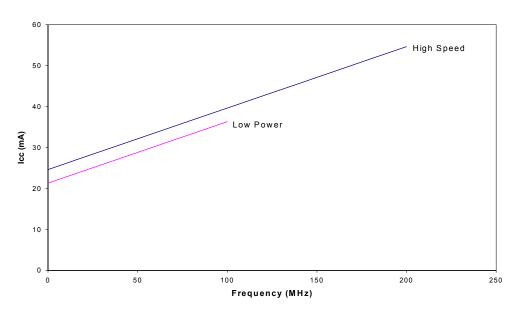






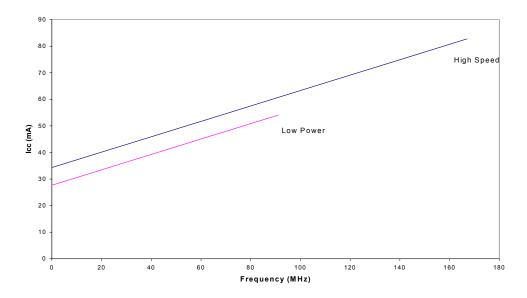
Power Consumption

Typical 5.0V Power Consumption CY37032



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled. $V_{CC} = 5.0V,\, T_A = Room\, Temperature$

CY37064

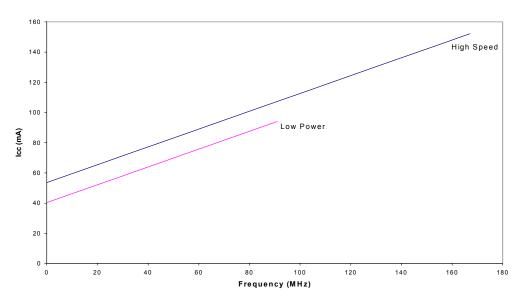


The typical pattern is a 16-bit up counter, per logic block, with outputs disabled. $V_{\rm CC} = 5.0V,\, T_{\rm A} = {\rm Room\ Temperature}$



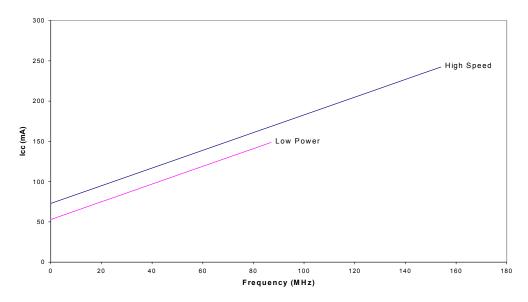


Typical 5.0V Power Consumption (continued) **CY37128**



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled. $V_{CC} = 5.0V,\, T_A = Room\, Temperature$

CY37192

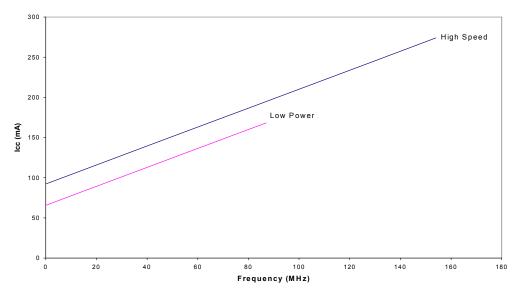


The typical pattern is a 16-bit up counter, per logic block, with outputs disabled. V_{CC} = 5.0V, T_A = Room Temperature



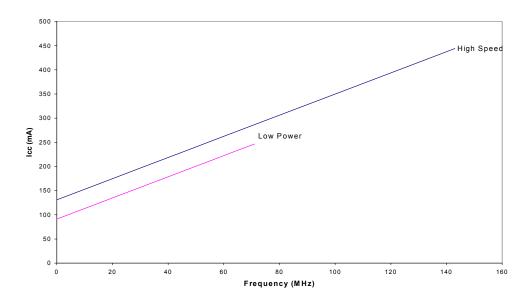


Typical 5.0V Power Consumption (continued) **CY37256**



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled. $V_{CC} = 5.0V,\, T_A = Room\, Temperature$

CY37384



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled. $V_{CC} = 5.0V,\, T_A = Room\, Temperature$





Pin Configurations^[20] (continued)

256-Ball Fine-Pitch BGA (BB256) Top View

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
Α	GND	GND	I/O ₂₆	I/O ₂₄	I/O ₂₀	V _{CC}	I/O ₁₁	GND	GND	I/O ₁₈₆	V _{CC}	I/O ₁₇₇	I/O ₁₇₂	I/O ₁₆₇	GND	GND
В	GND	I/O ₂₇	I/O ₂₅	I/O ₂₃	I/O ₁₉	I/O ₁₅	I/O ₁₀	GND	GND	I/O ₁₈₅	I/O ₁₈₁	I/O ₁₇₆	I/O ₁₇₁	I/O ₁₆₆	I/O ₁₆₅	GND
С	I/O ₂₉	I/O ₂₈	NC	I/O ₂₂	I/O ₁₈	I/O ₁₄	I/O ₉	I/O ₄	I/O ₁₉₁	I/O ₁₈₄	I/O ₁₈₀	I/O ₁₇₅	I/O ₁₇₀	NC	I/O ₁₆₃	I/O ₁₆₄
D	I/O ₃₂	I/O ₃₁	I/O ₃₀	NC	I/O ₁₇	I/O ₁₃	I/O ₈	I/O ₃	I/O ₁₉₀	I/O ₁₈₃	I/O ₁₇₉	I/O ₁₇₄	I/O ₁₆₉	I/O ₁₆₀	I/O ₁₆₁	I/O ₁₆₂
E	I/O ₃₅	I/O ₃₄	I/O ₃₃	I/O ₂₁	I/O ₁₆	I/O ₁₂	I/O ₇	I/O ₂	I/O ₁₈₉	V _{CC}	I/O ₁₇₈	I/O ₁₇₃	I/O ₁₆₈	I/O ₁₅₇	I/O ₁₅₈	I/O ₁₅₉
F	V _{CC}	I/O ₃₈	I/O ₃₇	I/O ₃₆	TCK	V _{CC}	I/O ₆	I/O ₁	I/O ₁₈₈	I/O ₁₈₂	V _{CC}	TDI	I/O ₁₅₄	I/O ₁₅₅	I/O ₁₅₆	V _{CC}
G	I/O ₄₃	I/O ₄₂	I/O ₄₁	I/O ₄₀	V _{CC}	I/O ₃₉	I/O ₅	I/O ₀	I/O ₁₈₇	I/O ₁₄₈	I/O ₁₄₉	CLK ₃ /I ₄	I/O ₁₅₀	I/O ₁₅₁	I/O ₁₅₂	I/O ₁₅₃
Н	GND	GND	I/O ₄₇	I/O ₄₆	CLK ₀ /I ₀	I/O ₄₅	I/O ₄₄	GND	GND	I/O ₁₄₄	I/O ₁₄₅	CLK ₂ /I ₃	I/O ₁₄₆	I/O ₁₄₇	GND	GND
J	GND	GND	I/O ₅₁	I/O ₅₀	NC	I/O ₄₉	I/O ₄₈	GND	GND	I/O ₁₄₀	I/O ₁₄₁	l ₂	I/O ₁₄₂	I/O ₁₄₃	GND	GND
K	I/O ₅₇	I/O ₅₆	I/O ₅₅	I/O ₅₄	CLK ₁	I/O ₅₃	I/O ₅₂	I/O ₉₁	I/O ₉₆	I/O ₁₀₁	I/O ₁₃₅	V _{CC}	I/O ₁₃₆	I/O ₁₃₇	I/O ₁₃₈	I/O ₁₃₉
L	V _{CC}	I/O ₆₀	I/O ₅₉	I/O ₅₈	TMS	V _{CC}	I/O ₈₆	I/O ₉₂	I/O ₉₇	I/O ₁₀₂	V _{CC}	TDO	I/O ₁₃₂	I/O ₁₃₃	I/O ₁₃₄	V _{CC}
M	I/O ₆₃	I/O ₆₂	I/O ₆₁	I/O ₇₂	I/O ₇₇	I/O ₈₂	V _{CC}	I/O ₉₃	I/O ₉₈	I/O ₁₀₃	I/O ₁₀₈	I/O ₁₁₂	I/O ₁₁₇	I/O ₁₂₉	I/O ₁₃₀	I/O ₁₃₁
N	I/O ₆₆	I/O ₆₅	I/O ₆₄	I/O ₇₃	I/O ₇₈	I/O ₈₃	I/O ₈₇	I/O ₉₄	I/O ₉₉	I/O ₁₀₄	I/O ₁₀₉	I/O ₁₁₃	NC	I/O ₁₂₆	I/O ₁₂₇	I/O ₁₂₈
Р	I/O ₆₈	I/O ₆₇	NC	I/O ₇₄	I/O79	I/O ₈₄	I/O ₈₈	I/O ₉₅	I/O ₁₀₀	I/O ₁₀₅	I/O ₁₁₀	I/O ₁₁₄	I/O ₁₁₈	NC	I/O ₁₂₄	I/O ₁₂₅
R	GND	I/O ₆₉	I/O ₇₀	I/O ₇₅	I/O ₈₀	I/O ₈₅	I/O ₈₉	GND	GND	I/O ₁₀₆	I/O ₁₁₁	I/O ₁₁₅	I/O ₁₁₉	I/O ₁₂₁	I/O ₁₂₃	GND
Т	GND	GND	I/O ₇₁	I/O ₇₆	I/O ₈₁	V _{CC}	I/O ₉₀	GND	GND	I/O ₁₀₇	V _{CC}	I/O ₁₁₆	I/O ₁₂₀	I/O ₁₂₂	GND	GND





Pin Configurations^[20] (continued)

388-Lead PBGA (BG388) Top View

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26
Α	GND	GND	I/O ₁₉	I/O ₁₅	I/O ₁₃	I/O ₃₄	I/O ₃₁	I/O ₂₈	I/O ₂₅	I/O ₁₀	I/O ₇	I/O ₄	I/O ₁	I/O ₂₆₃	I/O ₂₆₀	I/O ₂₅₇	I/O ₂₅₄	I/O ₂₃₉	I/O ₂₃₇	I/O ₂₃₂	I/O ₂₂₉	I/O ₂₅₀	I/O ₂₄₈	I/O ₂₄₄	GND	GND
В	GND	NC	I/O ₁₈	I/O ₁₇	I/O ₁₄	I/O ₃₅	I/O ₃₂	I/O ₂₉	I/O ₂₆	I/O ₁₁	I/O ₈	I/O ₅	I/O ₂	V _{CC}	I/O ₂₆₁	I/O ₂₅₈	I/O ₂₅₅	I/O ₂₅₂	I/O ₂₃₄	I/O ₂₃₁	I/O ₂₂₈	I/O ₂₄₉	I/O ₂₄₆	I/O ₂₄₅	I/O ₂₄₀	GND
С	I/O ₂₃	I/O ₃₈	I/O ₃₇	I/O ₁₆	I/O ₁₂	I/O ₃₃	I/O ₃₀	I/O ₂₇	I/O ₂₄	I/O ₉	I/O ₆	I/O ₃	I/O ₀	I/O ₂₆₂	I/O ₂₅₉	I/O ₂₅₆	I/O ₂₅₃	I/O ₂₃₈	I/O ₂₃₅	I/O ₂₃₃	I/O ₂₃₀	I/O ₂₅₁	I/O ₂₄₇	I/O ₂₂₅	I/O ₂₂₄	I/O ₂₂₇
D	I/O ₃₉	I/O ₄₀	I/O ₃₆	NC	NC	I/O ₂₁	I/O ₂₀	V _{CCO}	V _{CCO}	NC	GND	GND	V _{CCO}	V _{CCO}	GND	GND	NC	V _{CCO}	V _{CCO}	I/O ₂₃₆	I/O ₂₄₃	NC	NC	I/O ₂₂₆	I/O ₂₂₂	I/O ₂₂₃
Е	I/O ₄₂	TCK	I/O ₄₁	NC																			NC	TDI	I/O ₂₂₁	I/O ₂₂₀
F	I/O ₄₅	I/O ₄₄	I/O ₄₃	I/O ₂₂																			I/O ₂₄₂	I/O ₂₁₉	I/O ₂₁₈	I/O ₂₁₇
G	I/O ₄₈	I/O ₄₇	I/O ₄₆	I/O ₆₃																			I/O ₂₄₁	I/O ₂₁₆	I/O ₂₁₅	I/O ₂₁₄
Н	I/O ₄₉	I/O ₅₀	I/O ₅₁	V _{cco}																			V _{CCO}	I/O ₂₁₁	I/O ₂₁₂	I/O ₂₁₃
J	I/O ₅₂	I/O ₅₃	I/O ₅₄	V _{cco}																			V _{CCO}	I/O ₂₀₈	I/O ₂₀₉	I/O ₂₁₀
K	I/O ₅₅	I/O ₅₆	I/O ₅₇	NC																			NC	I/O ₂₀₅	I/O ₂₀₆	I/O ₂₀₇
L	10	I/O ₅₉	I/O ₅₈	GND							GND	GND	GND	GND	GND	GND							GND	I/O ₂₀₄	14	I/O ₁₉₇
М	I/O ₆₁	I/O ₆₀	I1	GND							GND	GND	GND	GND	GND	GND							GND	13	I/O ₂₀₃	I/O ₂₀₂
N	I/O ₆₄	V _{CC}	I/O ₆₂	V _{cco}							GND	GND	GND	GND	GND	GND							V _{CCO}	I/O ₂₀₁	I/O ₂₀₀	I/O ₁₉₉
Р	I/O ₆₅	I/O ₆₆	I/O ₆₇	V _{cco}							GND	GND	GND	GND	GND	GND							V _{CCO}	I/O ₁₉₆	V _{CC}	I/O ₁₉₈
R	I/O ₆₈	I/O ₆₉	I/O ₇₀	GND							GND	GND	GND	GND	GND	GND							GND	I/O ₁₉₃	I/O ₁₉₄	I/O ₁₉₅
Т	I/O ₇₁	I/O ₈₄	I/O ₈₅	GND							GND	GND	GND	GND	GND	GND							GND	I/O ₁₇₈	I/O ₁₇₉	I/O ₁₉₂
U	I/O ₈₈	I/O ₈₇	I/O ₈₆	NC																			NC	I/O ₁₇₇	I/O ₁₇₆	I/O ₁₇₅
٧	I/O ₉₁	I/O ₉₀	I/O ₈₉	V _{CCO}																			V _{CCO}	I/O ₁₇₄	I/O ₁₇₃	I/O ₁₇₂
W	I/O ₉₄	I/O ₉₃	I/O ₉₂	V _{CCO}																			V _{CCO}	I/O ₁₇₁	I/O ₁₇₀	I/O ₁₆₉
Υ	I/O ₉₅	I/O ₇₂	I/O ₇₃	I/O ₁₁₀																			I/O ₁₅₃	I/O ₁₉₀	I/O ₁₉₁	I/O ₁₆₈
AA	I/O ₇₄	I/O ₇₅	I/O ₇₆	I/O ₁₁₁																			I/O ₁₅₂	I/O ₁₈₇	I/O ₁₈₈	I/O ₁₈₉
AB	I/O ₇₇	I/O ₇₈	I/O ₇₉	N/C																			NC	I/O ₁₈₄	I/O ₁₈₅	I/O ₁₈₆
AC	I/O ₈₁	I/O ₈₀	I/O ₁₀₈	N/C	NC	I/O ₁₁₂	I/O ₁₁₃	V _{CCO}	V _{CCO}	NC	GND	GND	V _{CCO}	V _{CCO}	GND	GND	NC	V _{CCO}	V _{CCO}	I/O ₁₅₀	I/O ₁₅₁	NC	NC	I/O ₁₅₅	I/O ₁₈₃	I/O ₁₈₂
AD	I/O ₁₀₉	I/O ₈₂	I/O ₈₃	I/O ₁₁₇	I/O ₉₇	I/O ₁₀₀	I/O ₁₀₂	I/O ₁₀₅	I/O ₁₂₀	I/O ₁₂₃	I/O ₁₂₆	I/O ₁₂₉	12	I/O ₁₃₃	I/O ₁₃₆	I/O ₁₃₉	I/O ₁₄₂	I/O ₁₅₇	I/O ₁₅₉	I/O ₁₆₁	I/O ₁₆₃	I/O ₁₆₆	I/O ₁₄₆	I/O ₁₈₀	I/O ₁₈₁	I/O ₁₅₄
AE	GND	NC	I/O ₁₁₅	I/O ₁₁₆	I/O ₁₁₉	I/O ₉₈	I/O ₁₀₁	I/O ₁₀₃	I/O ₁₀₆	I/O ₁₂₁	I/O ₁₂₄	I/O ₁₂₇	V _{CC}	I/O ₁₃₀	I/O ₁₃₄	I/O ₁₃₇	I/O ₁₄₀	I/O ₁₄₃	I/O ₁₆₀	I/O ₁₆₂	I/O ₁₆₅	I/O ₁₄₄	I/O ₁₄₇	I/O ₁₄₈	NC	GND
AF	GND	GND	I/O ₁₁₄	I/O ₁₁₈	I/O ₉₆	I/O ₉₉	TMS	I/O ₁₀₄	I/O ₁₀₇	I/O ₁₂₂	I/O ₁₂₅	I/O ₁₂₈	I/O ₁₃₁	I/O ₁₃₂	I/O ₁₃₅	I/O ₁₃₈	I/O ₁₄₁	I/O ₁₅₆	I/O ₁₅₈	TDO	I/O ₁₆₄	I/O ₁₆₇	I/O ₁₄₅	I/O ₁₄₉	GND	GND



5.0V Ordering Information (continued)

Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
64	154	CY37064P44-154AC	A44	44-Lead Thin Quad Flat Pack	Commercial
		CY37064P44-154JC	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37064P84-154JC	J83	84-Lead Plastic Leaded Chip Carrier	
		CY37064P100-154AC	A100	100-Lead Thin Quad Flat Pack	
		CY37064P44-154AI	A44	44-Lead Thin Quad Flat Pack	Industrial
		CY37064P44-154AXI	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37064P44-154JI	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37064P44-154JXI	J67	44-Lead Lead Free Plastic Leaded Chip Carrier	
		CY37064P84-154JI	J83	84-Lead Plastic Leaded Chip Carrier	
		CY37064P100-154AI	A100	100-Lead Thin Quad Flat Pack	
		5962-9951902QYA	Y67	44-Lead Ceramic Leadless Chip Carrier	Military
	125	CY37064P44-125AC	A44	44-Lead Thin Quad Flat Pack	Commercial
		CY37064P44-125AXC	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37064P44-125JC	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37064P44-125JXC	J67	44-Lead Lead Free Plastic Leaded Chip Carrier	
		CY37064P84-125JC	J83	84-Lead Plastic Leaded Chip Carrier	
		CY37064P100-125AC	A100	100-Lead Thin Quad Flat Pack	
		CY37064P100-125AXC	A100	100-Lead Lead Free Thin Quad Flat Pack	
		CY37064P44-125AI	A44	44-Lead Thin Quad Flat Pack	Industrial
		CY37064P44-125AXI	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37064P44-125JI	J67	44-Lead Plastic Leaded Chip Carrier	1
		CY37064P84-125JI	J83	84-Lead Plastic Leaded Chip Carrier	1
		CY37064P100-125AI	A100	100-Lead Thin Quad Flat Pack	1
		CY37064P100-125AXI	A100	100-Lead Lead Free Thin Quad Flat Pack	1
		5962-9951901QYA	Y67	44-Lead Ceramic Leadless Chip Carrier	Military



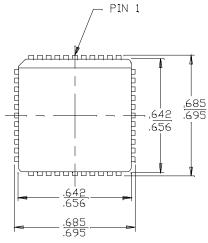
5.0V Ordering Information (continued)

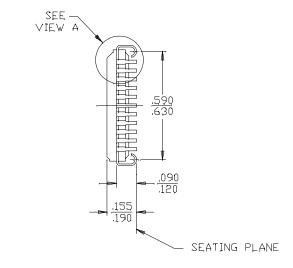
Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
128	167	CY37128P84-167JC	J83	84-Lead Plastic Leaded Chip Carrier	Commercial
		CY37128P84-167JXC	J83	84-Lead Lead Free Plastic Leaded Chip Carrier	1
		CY37128P100-167AC	A100	100-Lead Thin Quad Flat Pack	
		CY37128P100-167AXC	A100	100-Lead Lead Free Thin Quad Flat Pack	
		CY37128P160-167AC	A160	160-Lead Thin Quad Flat Pack	
		CY37128P160-167AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
	125	CY37128P84-125JC	J83	84-Lead Plastic Leaded Chip Carrier	Commercia
		CY37128P84-125JXC	J83	84-Lead Lead Free Plastic Leaded Chip Carrier	
		CY37128P100-125AC	A100	100-Lead Thin Quad Flat Pack	
		CY37128P100-125AXC	A100	100-Lead Lead Free Thin Quad Flat Pack	
		CY37128P160-125AC	A160	160-Lead Thin Quad Flat Pack	
		CY37128P160-125AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
		CY37128P84-125JI	J83	84-Lead Plastic Leaded Chip Carrier	Industrial
		CY37128P84-125JXI	J83	84-Lead Lead Free Plastic Leaded Chip Carrier	
		CY37128P100-125AI	A100	100-Lead Thin Quad Flat Pack	
		CY37128P100-125AXI	A100	100-Lead Lead Free Thin Quad Flat Pack	1
		CY37128P160-125AI	A160	160-Lead Thin Quad Flat Pack	1
		CY37128P160-125AXI	A160	160-Lead Lead Free Thin Quad Flat Pack	1
		5962-9952102QYA	Y84	84-Lead Ceramic Leaded Chip Carrier	Military
	100	CY37128P84-100JC	J83	84-Lead Plastic Leaded Chip Carrier	Commercia
		CY37128P84-100JXC	J83	84-Lead Lead Free Plastic Leaded Chip Carrier	1
		CY37128P100-100AC	A100	100-Lead Thin Quad Flat Pack	+
		CY37128P100-100AXC	A100	100-Lead Lead Free Thin Quad Flat Pack	1
		CY37128P160-100AC	A160	160-Lead Thin Quad Flat Pack	+
		CY37128P160-100AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	=
		CY37128P84-100JI	J83	84-Lead Plastic Leaded Chip Carrier	Industrial
		CY37128P100-100AI	A100	100-Lead Thin Quad Flat Pack	=
		CY37128P100-100AXI	A100	100-Lead Lead Free Thin Quad Flat Pack	=
		CY37128P160-100AI	A160	160-Lead Thin Quad Flat Pack	
		5962-9952101QYA	Y84	84-Lead Ceramic Leaded Chip Carrier	Military
192	154	CY37192P160-154AC	A160	160-Lead Thin Quad Flat Pack	Commercia
-		CY37192P160-154AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
	125	CY37192P160-125AC	A160	160-Lead Thin Quad Flat Pack	Commercia
		CY37192P160-125AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	+
		CY37192P160-125AI	A160	160-Lead Thin Quad Flat Pack	Industrial
		CY37192P160-125AXI	A160	160-Lead Lead Free Thin Quad Flat Pack	1
	83	CY37192P160-83AC	A160	160-Lead Thin Quad Flat Pack	Commercia
		CY37192P160-83AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	†
		CY37192P160-83AI	A160	160-Lead Thin Quad Flat Pack	Industrial
		CY37192P160-83AXI	A160	160-Lead Lead Free Thin Quad Flat Pack	+

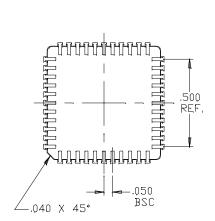


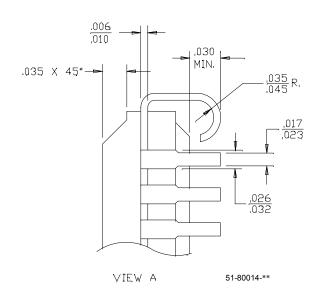


44-Lead Ceramic Leaded Chip Carrier Y67





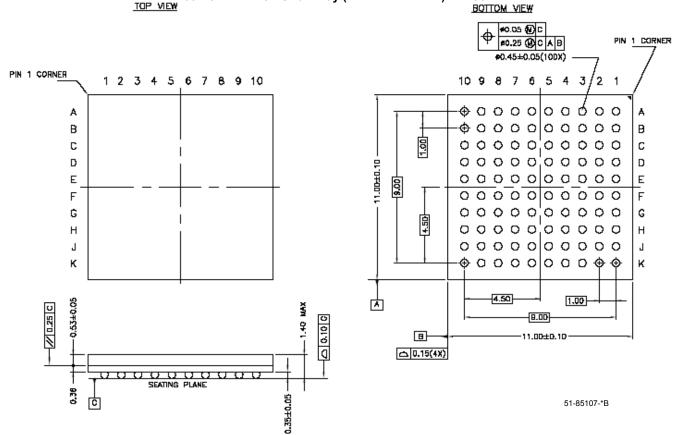








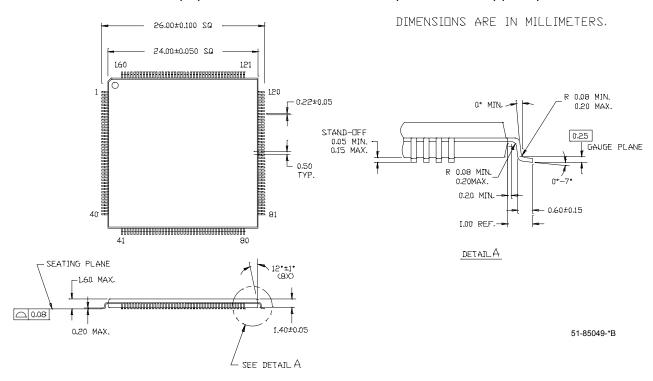
100-Ball Thin Ball Grid Array (11 x 11 x 1.4 mm) BB100







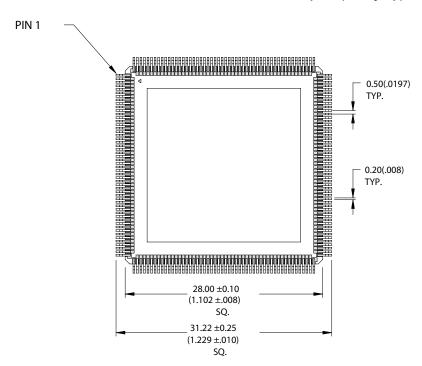
160-Lead Lead (Pb)-Free Thin Plastic Quad Flat Pack (24 x 24 x 1.4 mm) (TQFP) A160



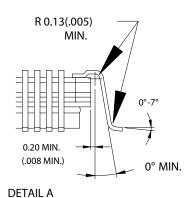


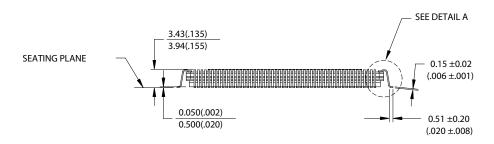


208-Lead Ceramic Quad Flatpack (Cavity Up) U208



DIMENSIONS IN MM (INCH) REFERENCE JEDEC: N/A PKG. WEIGHT: 6-7gms



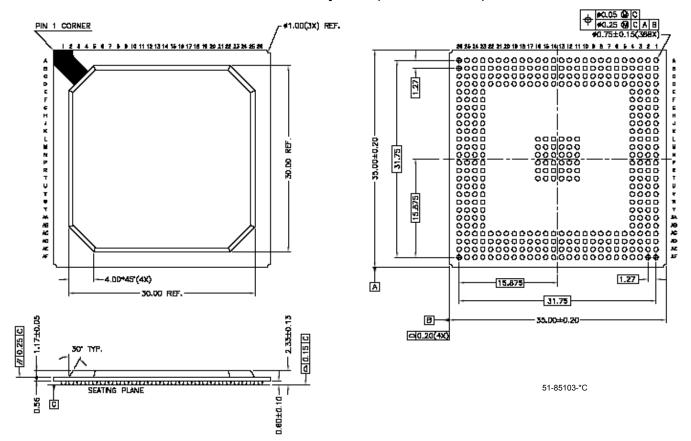


51-80105-*B





388-Ball Plastic Ball Grid Array PBGA (35 x 35 x 2.33 mm) BG388







Document History Page

Document Title: Ultra37000 CPLD Family 5V, 3.3V, ISR™ High-Performance CPLDs Document Number: 38-03007				
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change
**	106272	04/18/01	SZV	Change from Spec number: 38-00475 to 38-03007
*A	124942	03/21/03	OOR	Updated 3.3V V _{CC} requirements for –144 speeds Added an Addendum
*B	126262	05/09/03	TEH	Changed pinout for CY37128V BB100 package
*C	128125	07/16/03	НОМ	Obsoleted following 3.3V PLCC packaged devices: CY37032VP44-143JC CY37032VP44-100JC CY37064VP44-143JC CY37064VP84-143JC CY37064VP44-100JC CY37064VP84-100JC CY37064VP84-100JI CY37064VP84-100JI CY37128VP84-125JC CY37128VP84-83JI
*D	282709	See ECN	YDT	Changed package diagrams and labels for consistency Added Lead (Pb)-free logo on first page, as well as a note in Features Added Lead (Pb)-free package diagram labels Added Lead-free Parts to Ordering Information CY37032P44-200AXC, CY37032P44-200JXC, CY37032P44-154AXI, CY37032P44-154JXI, CY37032P44-125AXC, CY37032P44-125JXC, CY37064P44-200AXC, CY37064P44-200JXC, CY37064P100-200AXC, CY37064P44-154JXI, CY37064P44-154JXI, CY37064P44-125AXC, CY37064P44-125JXC, CY37064P100-125AXC, CY37064P44-125AXI, CY37064P41-125JXC, CY37128P84-167JXC, CY37128P100-167AXC, CY37128P160-167AXC, CY37128P84-125JXI, CY37128P100-125AXI, CY37128P160-125AXI, CY37128P84-125JXI, CY37128P100-125AXI, CY37128P160-125AXI, CY37128P84-100JXC, CY37128P100-100AXC, CY37128P160-125AXI, CY37128P84-100JXC, CY37128P100-100AXC, CY37192P160-125AXC, CY37128P100-100AXI, CY37192P160-154AXC, CY37192P160-83AXI, CY37256P160-154AXC, CY37256P160-83AXI, CY37032VP44-143AXC, CY37032VP44-100AXC, CY37032VP44-100AXI, CY37032VP44-100JXI, CY37064VP100-100AXC, CY37064VP100-143AXC, CY37064VP44-100AXC, CY37064VP100-100AXC, CY37064VP44-100AXI, CY37064VP44-100AXI, CY37128VP100-83AXC, CY37128VP160-125AXC, CY37128VP160-125AXI, CY37128VP100-83AXI, CY37128VP160-125AXC, CY37128VP100-83AXI, CY37128VP100-83AXI, CY37128VP160-125AXI, CY37064VP46-100AXI, CY37128VP100-83AXI, CY37128VP160-125AXI, CY37128VP100-83AXI, CY37128VP100-83AXI, CY37128VP160-125AXI, CY37128VP160-66AXC, CY37256VP160-100AXC, CY37256VP160-100AXI, CY37256VP160-66AXC
*E	321635	See ECN	PCX	Added Package Diagram BG292 Updated all PBGA package type information (BG292 & BG388)